Title: Qualification of additional Fab site (RFAB) and Assembly/Test site (TIPI & I options for the TLV6001 device family					HFTF)									
Customer Contact:			PCN Manager			Dept:			Quality Services					
Proposed 1 st Ship Date:			Mar 03	3 201	٥	Estim			mp			vided at		
		<u> </u>		Mai U.	201	. .	Availa	abilit	ty:		sa	mple	request.	
	nge Typ													
					bly Pro			\boxtimes		Assembly	•			
	Design						cification		Щ				ecification	
	Test Sit			Packing/Shipping/Labeling			Щ	_	est Prod					
		Sump Site				Bump Material				Wafer Bump Process				
\boxtimes	Wafer F	ab Site		✓ Wafer Fab Materials✓ Part number change			Wafer Fab Process							
				P		PCN Details								
Doc	cription	of Change				PCN D	etaiis							
Des	cription	of Change:												
		ments is pleasest site (TIPI 8			ons f	or the T	LV6001 dev				ab site	(RFAE	3) and	
					Add	ditiona	Fab Site							
		Fab Site	Pro	cess		afer meter	Fab Site	Pro	осе	SS	Waf Diame			
		DP1DM5	HF	PA07	200	0 mm	RFAB	L	BC9)	300 r	nm		
Ass	embly co	nstruction diff	eren	ces are	as fo		,		ge	•		(°	TIDI)	
-	Mount	Compound			Current (NFME) SID# A-03				Additional (TIPI) 4207123					
-		ompound				SID# A-03 SID#R-13				4222198				
-		rire composit	tion	'diame	eter	Au/1.0 mils				Au/1.0 mils or Cu/0.8				
	MSL					LEVEL2-260CG				mils LEVEL1-260CG				
	MSL					LI	_VLLZ-200C				LEVEL	.1-20	UCG	
Ass	embly co	nstruction diff	eren	ces are	as fo	ollows (HFTF, DCK	Pack	age	onl	y):			
						Cu	rrent (NFM	1E)			Additio	nal (F	HFTF)	
	Mold Co	ompound					SID# R-07				SID	#R-2	7	
	Bond w	rire composit	tion/	'diame	eter	Au/1.0 mils			Au/1.0 mils or Cu/0.8 mils					
	MSL				LEVEL1-260CG			LEVEL2-260CG						
Test coverage, insertions, conditions will remain consistent with current testing and verified with test MQ.														
Reason for Change:														
Continuity of Supply														
Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):														
None														
Ant	icipated	impact on M	late	rial De	clara	tion								
	No Impact to the Material Declarations or Product Content reports are driven from production data and will be available following the production release. Upon production release the revised reports can be obtained from the TI ECO website.													

PCN Number:

PCN#20181130001.1

PCN Date: Dec 03 2018

Changes to product identification resulting from this PCN:

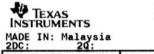
Fab Site Information:

Chip Site	Chip Site Origin Code (20L)	Chip Site Country Code (21L)	Chip Site City
DP1DM5	DM5	USA	Dallas
RFAB	RFB	USA	Richardson

Assembly Site Information:

Assembly Site	Assembly Site Origin (22L)	Assembly Country Code (21L)	Assembly City
NFME	NFM	CHN	Economic Development Zone
TIPI	PHI	PHL	Baguio City
HFTF	HFT	CHN	Hefei

Sample product shipping label (not actual product label)



MSL 2 /260C/1 YEAR SEAL DT MSL 1 /235C/UNLIM 03/29/04

OPT: ITEM:

5A (L)T0:39750



(1P) \$N74L\$07N\$R (Q) 2000 (D) 0336 (31T)LOT: 3959047MLA (4W) TKY(1T) 7523483\$I2 (P) (2P) REV: (V) 0033317

(2P) REV: (V) 0033317 (20L) CSO: SHE (31L) CCO:USA (22L) ASO: MLA (23L) ACO: MYS

Product Affected:

Group 1 Device list (Additional Fab (RFAB) site plus AT (TIPI) Qualification:

TLV6001IDBVR TLV6001IDBVT TLV6001UIDBVR TLV6001UIDBVT

Group 2 Device list (Additional Fab (RFAB) plus AT (HFTF) Qualification):

TLV6001IDCKR TLV6001IDCKT



Qualification Report

Approved - 09-Nov-2018

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: : TLV6001IDBVR/T	QBS Process Reference: TLV9002ID	QBS Process Reference: TLV9062ID
ED	Electrical Characterization	Per Datasheet Parameters	Pass	Pass	Pass
ELFR	Early Life Failure Rate, 125C	48 Hours	-	-	3/2399/0
HAST	Biased HAST, 130C/85%RH	96 Hours	3/231/0	1/77/0	3/231/0
HBM	ESD - HBM	2000 V	1/3/0	1/3/0	3/12/0
CDM	ESD - CDM	1000 V	1/3/0	1/3/0	3/9/0
HTOL	Life Test, 150C	300 Hours	-	1/77/0	3/231/0
HTSL	High Temp. Storage Bake, 170C	420 Hours	3/231/0	1/77/0	3/231/0
LU	Latch-up	(per JESD78)	1/6/0	1/6/0	3/18/0
SD	Solderability	Pb Free	-	-	3/66/0
TC	Temperature Cycle, -65/150C	500 Cycles	3/231/0	1/76/0	3/231/0
UHAST	Unbiased HAST, 130C/85%RH	96 Hours	3/231/0	1/77/0	3/231/0

- QBS: Qual By Similarity
- Qual Device TLV6001IDBVR/T is qualified at LEVEL1-260C
- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

 The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

 The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours

 The following are equivalent Temp Cycle options per JESD47: -55C/125C/700 Cycles and -65C/150C/500 Cycles

 Quality and Environmental data is available at Ti's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green



TI Information Selective Disclosure

Qualification Report

Approve Date 08-Nov-2018

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: TLV6001IDCKR/T	QBS Process Reference: TLV9002ID	QBS Process Reference: <u>TLV9062ID</u>
ED	Electrical Characterization	Per Datasheet Parameters	Pass	Pass	Pass
ELFR	Early Life Failure Rate, 125C	48 Hours	-	-	3/2399/0
HAST	Biased HAST, 130C/85%RH	96 Hours	3/231/0	1/77/0	3/231/0
HBM	ESD - HBM	2000 V	1/3/0	1/3/0	3/9/0
CDM	ESD - CDM	1000 V	1/3/0	1/3/0	3/9/0
HTOL	Life Test, 150C	300 Hours	-	1/77/0	3/231/0
HTSL	High Temp Storage Bake 170C	420 Hours	3/231/0	1/77/0	3/231/0
LU	Latch-up	(per JESD78)	1/6/0	1/6/0	3/18/0
SD	Solderability	Pb Free	-	-	3/66/0
TC	Temperature Cycle, -65/150C	500 Cycles	3/231/0	1/76/0	3/231/0
UHAST	Unbiased HAST, 130C/85%RH	96 Hours	3/231/0	1/77/0	3/231/0

- QBS: Qual By Similarity
- Qual Device TLV6001IDCKR/T is qualified at LEVEL2-260C
- Preconditioning was performed for Autodave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours
 The following are equivalent Temp Cycle options per JESD47: -55C/125C/700 Cycles and -65C/150C/500 Cycles
- Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green



Qualification Report

Approve Date 09-Nov-2018

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: TLV6001UIDBVR/T	QBS Process Reference: <u>TLV9002ID</u>	QBS Process Reference: <u>TLV9062ID</u>	QBS Package Reference: <u>TLV9001IDBVR</u>
ED	Electrical Characterization	Per Datasheet Parameters	Pass	Pass	Pass	Pass
ELFR	Early Life Failure Rate, 125C	48 Hours	-	-	3/2399/0	-
HAST	Biased HAST, 130C/85%RH	96 Hours	-	1/77/0	3/231/0	3/231/0
HBM	ESD - HBM	2000 V	1/3/0	1/3/0	3/9/0	1/3/0
CDM	ESD - CDM	1000 V	1/3/0	1/3/0	3/9/0	1/3/0
HTOL	Life Test, 150C	300 Hours	-	1/77/0	3/231/0	-
HTSL	High Temp. Storage Bake, 170C	420 Hours	-	1/77/0	3/231/0	3/231/0
LU	Latch-up	(per JESD78)	1/6/0	1/6/0	3/18/0	1/6/0
SD	Solderability	Pb Free	-	-	3/66/0	-
TC	Temperature Cycle, -65/150C	500 Cycles	-	1/76/0	3/231/0	3/231/0
UHAST	Unbiased HAST, 130C/85%RH	96 Hours	-	1/77/0	3/231/0	3/231/0

⁻ QBS: Qual By Similarity

Qualified Pb-Free(SMT) and Green

For questions regarding this notice, e-mails can be sent to the regional contacts shown below, or you can contact your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com

⁻ Qual Device TLV6001UIDBVR/T is qualified at LEVEL1-260C
- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options per JESD47: -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/ Green/Pb-free Status: